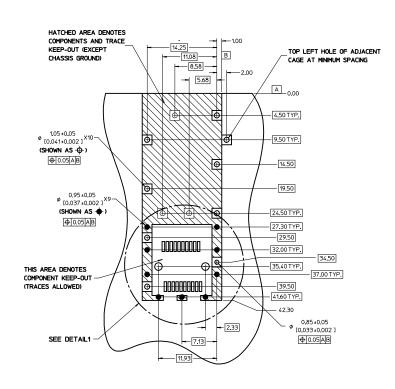
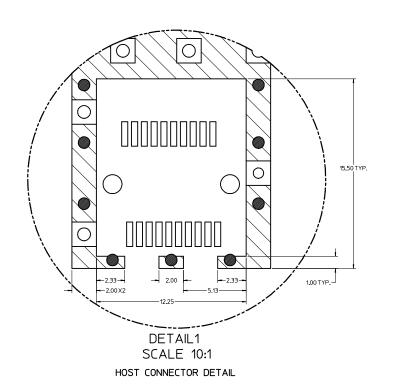


PCB LAYOUT FOR SINGLE SIDE MOUNT

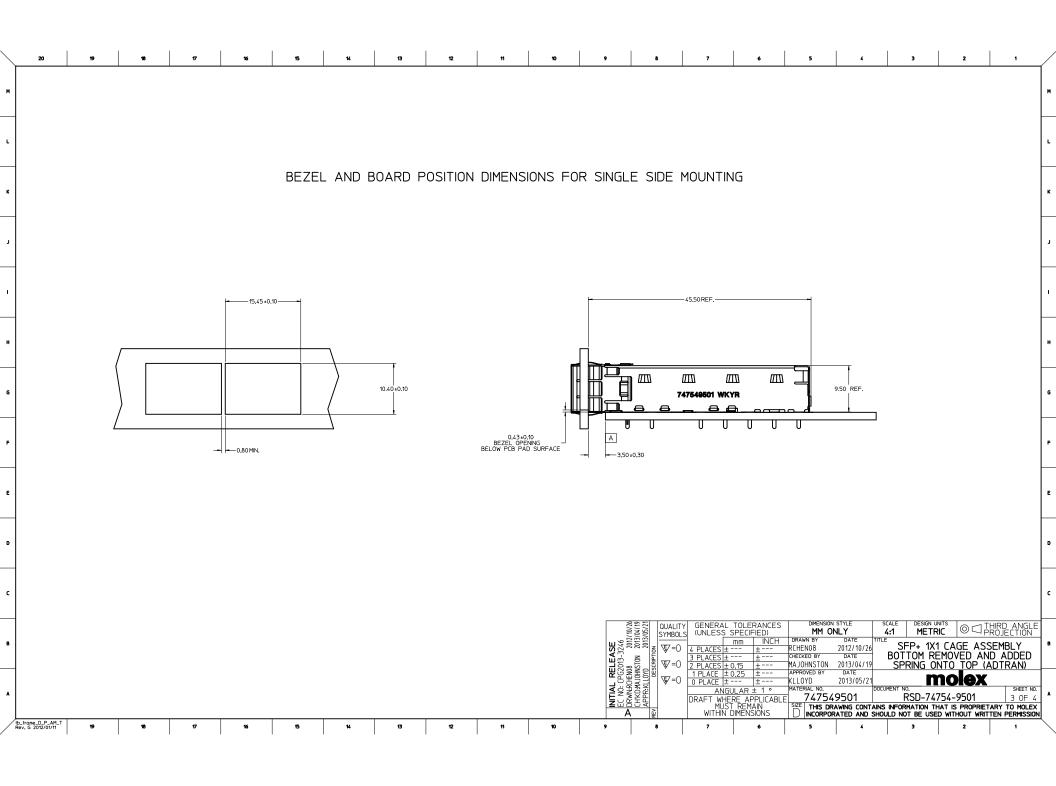




NOTE:

- 1. PADS AND VIAS CONNECT TO CHASSIS GROUND (RECOMMEND PADS TO BE 2,00mm SQUARE)
- 2. FOR WAVE SOLDERING TO 3.3MM MAXIMUM THICK PCB.
- 3. CONNECTOR PAD LAYOUT PER SFP+ MSA WILL ACCOMMODATE MOLEX CONNECTOR SERIES 74441 OR EQUIVALENT.

710/76	3/05/21	QUALITY SYMBOLS	GENERAL (UNLESS S	TOLERANCES SPECIFIED)	DIMENSION MM OI	STYLE VLY	SCALE 4:1	DESIGN UN		HIRD ANGLE ROJECTION
.EASE	TON 201 201 RIPTION	₹ =0	4 PLACES ± - 3 PLACES ± -	mm INCH ± 2.15 +	RCHENO8 CHECKED BY MAJOHNSTON	DATE 2012/10/26 DATE 2013/04/19	SFF BOTT(SPRII	OM RE	MOVED AN	SEMBLY D ADDED ADTRAN)
AL REL	MAJOHNS KLLOYD DESC	№ =0	1 PLACE ± 0	0.25 ± ±	APPROVED BY KLLOYD MATERIAL NO.	DATE 2013/05/21	DOCUMENT NO.	n	<u>iolex</u>	SHEET NO.
<u> </u>	CH'KD APPR:		DRAFT WHEI	RE APPLICABLE	74754	9501 AWING CONTA	RS AINS INFORMA	2 OF 4 ARY TO MOLEX TEN PERMISSION		
9	8		7	6	5	4	3	3	2	1



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	DATE 2012/10/26	REV A	INITIAL R	PELEASE			ESCRIPTION									
_	2012/10/20		INTIAL IX	LLLAGE												
_																
								2000	CHYCLAN	LITY GENER BOLS (UNLES	AL TOLERANCE S SPECIFIED) mm INC	-3	MM ONLY BY DATE	1:1	METRIC	
								EASE 3-3244	NO 15	=O 4 PLACES	5 ±	CHECKED	BY DATE	/26 SF BOT	P+ 1X1 CA	VED AN
								5201		=0 2 PLACES	± 0.15 ± ± 0.25 ±	MA JOHN APPROVE	ISTON 2013/04 D BY DATE	/19 SP	RING ONTO	o top (A

